



PSR-4000 HFX Series (UL Name: PSR-4000DE / CA-40HF)

LIQUID PHOTOIMAGEABLE SOLDER MASK

- Application by Screen Printing
- **Blue Matte**
- **W** Halogen-Free
- RoHS Compliant
- Compatible with Lead-Free Processing
- **Tine Dam Resolution**
- Excellent Small Hole Clearing
- **Wide Processing Window**
- Excellent Resistance to ENIG and Immersion Tin

1 Page

Revised May 23, 2016



PROCESSING PARAMETERS FOR PSR-4000 HFX SERIES

PSR-4000 HFX Series includes a blue matte. It is a two-component, alkaline developable LPI solder mask product for screen printing application. This product is designed to be user friendly with a wide processing latitude. It has a very fast photospeed and good resistance to alternate metal finishes such as ENIG and Immersion Tin while maintaining solder dams of 2 mils or less. It also has very good small hole clearing capabilities. **PSR-4000 HFX Series** meet or exceed the requirements of IPC SM-840E Class H and Class T, Bellcore GR-78-CORE Issue 1, and have a UL flammability rating of 94V-0. All Taiyo America products comply with the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the Restriction of the use of certain Hazardous Substances (RoHS) in electrical and electronic equipment.

PSR-4000 HFX MAT	TE COMPONENT	S Mixing Ratio Colors <u>Mixed Properties</u> Solids Specific Gravity	PSR-4000 HFX 100 parts Blue 75% 1.39	/ CA-40HF 43 parts White	
MIXING	weight of 100 HFX can be can be done for 10 – 15 m	FX is supplied in p o parts PSR-4000 I mixed by hand with with a mechanical n ninutes. Also, mixing life after mixing is 7.	HFX blue and 43 a mixing spatula nixer at low speed g can be done with	parts CA-40HF. for 10 – 15 minut s to minimize she a paint shaker f	PSR-4000 tes. Mixing ar thinning or 10 – 15
Pre-Cleaning	cleaned. Va Mechanical E clean surface	er mask application, rious cleaning me Brush, and Chemica for the application o board should be he ces.	ethods include F al Clean. All of th of PSR-4000 HFX.	Pumice, Aluminu ese methods will Hold time after cl	m Oxide, provide a leaning the

2 Page

Revised May 23, 2016

2675 Antler Drive • Carson City, NV 89701 • Phone [775] 885-9959 • Fax [775] 885-9972 • www.taiyo-america.com



PROCESSING PARAMETERS FOR PSR-4000 HFX Series

SCREEN PRINTING	 Method: Single Sided and Double Sided Screening Screen Mesh: 74 – 110 Screen Mesh Angle: 22.5° Bias Screen Tension: 20 - 28 Newtons Squeegee: 60 – 80 durometer Squeegee Angle: 27 – 35° Printing Mode: Flood / Print / Print Flood Pressure: 20 – 30 psi Printing Speed: 2.0 – 9.9 inches/sec 		
TACK DRY CYCLE	 Printing Speed: 2.0 – 9.9 inches/sec Printing Pressure: 60 – 100 psi The Tack Dry step is required to remove solvent from the solder mask film and produce a firm dry surface. The optimum dwell time and oven temperature will depend on oven type, oven loading, air circulation, exhaust rate, and ramp times. Excessive tack dry times and temperature will result in difficulty developing solder mask from through holes and a reduction in photospeed. Insufficient tack dry will result in artwork marking and/or sticking. Typical tack dry conditions for PSR-4000 HFX are as follows: Oven Temperature: 150 - 185°F (65 - 85°C) For Single-Sided (Batch Oven) 1st Side: Dwell Time: 10 - 20 minutes 2nd Side: Dwell Time: 25 - 50 minutes 		

EXPOSURE

PSR-4000 HFX requires UV exposure to define solder mask dams and features. The spectral sensitivity of **PSR-4000 HFX** is in the area of 365 nm. Exposure times will vary by bulb type and age of the bulb. Below are guidelines for exposing **PSR-4000 HFX**.

- Exposure Unit: 7 kW or higher
- Stouffer Step 21: Clear 10 minimum (on metal / under phototool)
- Energy: 150 mJ/cm² minimum (under phototool)

3 | Page

Revised May 23, 2016

2675 Antler Drive • Carson City, NV 89701 • Phone [775] 885-9959 • Fax [775] 885-9972 • www.taiyo-america.com



PROCESSING PARAMETERS FOR PSR-4000 HFX Series

DEVELOPMENT	PSR-4000 HFX is developed in an aqueous sodium or potassium carbonate solution. Developing can be done in either a horizontal or vertical machine.			
	 Solution: 1% by wt. Sodium Carbonate or 1.2% Potassium Carbonate pH: 10.6 or greater Temperature: 85 - 95°F (29 - 35°C) Spray Pressure: 25 - 45 psi 			
	 Dwell Time in developing chamber: 45 - 90 seconds Water rinse is needed to remove developer solution followed by a drying step 			
FINAL CURE	PSR-4000 HFX needs to be thermally cured to insure optimal final property performance. Thermal curing can be done in a batch oven or conveyorized			
	oven.			

For Process Optimization please contact your local Taiyo America Representative

4 Page

Revised May 23, 2016

2675 Antler Drive • Carson City, NV 89701 • Phone [775] 885-9959 • Fax [775] 885-9972 • www.taiyo-america.com



FINAL PROPERTIES FOR PSR-4000 HFX Series

IPC-SM-840E, Class H & T, Solder Mask Vendor Testing Requirements

TEST	SM-840 PARAGRAPH	REQUIREMENT	RESULT
Visual	3.4.8	Uniform in Appearance	Pass
Curing	3.4.5	Ref: 3.6.1.1, 3.7.1 and 3.7.2	Pass
Non-Nutrient	3.4.6	Does not contribute to biological growth	Pass
Dimensional	3.4.10	No Solder Pickup and Withstand 500 VDC	Pass
Pencil Hardness	3.5.1	Minimum "F"	Pass – 7H
Adhesion	3.5.2	Rigid – Cu, Ni, FR-4	Pass
Machinability	3.5.3	No Cracking or Tearing	Pass
Resistance to Solvents and Cleaning Agents	3.6.1.1	Table 3 Solvents	Pass
Hydrolytic Stability and Aging	3.6.2	No Change after 28 days of 95-99°C and 90-98% RH	Pass
Solderability	3.7.1	No Adverse Effect J-STD-003	Pass
Resistance to Solder	3.7.2	No Solder Sticking	Pass
Resistance to Solder	3.7.3	No Solder Sticking	Pass
Simulation of Lead Free Reflow	3.7.3.1	No Solder Sticking	Pass
Dielectric Strength	3.8.1	500 VDC / mil Minimum	3200 VDC/mil
Thermal Shock	3.9.3	No Blistering, Crazing or De-lamination	Pass

Specific Class "H" Requirements

TEST	SM-840 PARAGRAPH	REQUIREMENT	RESULT	
Flammability	3.6.3	UL 94V-0	Pass – File #E166421 UL Name: PSR-4000 DE / CA-40 HF	
Insulation Resistance				
Before Soldering	3.8.2	5 x 10 ⁸ ohms minimum	Pass (8.60 x 10 ¹¹ ohms)	
After Soldering		5 x 10 ⁸ ohms minimum	Pass (1.98 x 10 ¹² ohms)	
Moisture & Insulation Resistance Before Soldering–In Chamber Before Soldering–Out of Chamber After Soldering-In Chamber After Soldering-Out of Chamber	3.9.1	5×10^8 ohms minimum 5×10^8 ohms minimum 5×10^8 ohms minimum 5×10^8 ohms minimum	Pass (7.6 x 10 ¹⁰ ohms) Pass (3.0 x 10 ¹² ohms) Pass (4.4 x 10 ¹⁰ ohms) Pass (2.4 x 10 ¹³ ohms)	
Electrochemical Migration	3.9.2	>2.0 x 10 ⁶ ohms, no dendritic growth	Pass (1.6 x 10 ¹² ohms)	

Revised May 23, 2016

2675 Antler Drive • Carson City, NV 89701 • Phone [775] 885-9959 • Fax [775] 885-9972 • www.taiyo-america.com



FINAL PROPERTIES FOR PSR-4000 HFX Series

Specific Class "T" Requirements

TEST	SM-840 PARAGRAPH	REQUIREMENT	RESULT
Flammability	3.6.3	Bellcore 02 Index – 28 minimum	Pass
Insulation Resistance			
Before Soldering	3.8.2	5 x 10 ⁸ ohms minimum	Pass (3.3 x 10 ¹³ ohms)
After Soldering		5 x 10 ⁸ ohms minimum	Pass (3.9 x 10 ¹² ohms)
Moisture & Insulation Resistance Before Soldering–In Chamber Before Soldering–Out of Chamber After Soldering-In Chamber After Soldering-Out of Chamber	3.9.1	5 x 10 ⁸ ohms minimum 5 x 10 ⁸ ohms minimum 5 x 10 ⁸ ohms minimum 5 x 10 ⁸ ohms minimum	Pass (3.1 x 10 ⁹ ohms) Pass (1.5 x 10 ¹³ ohms) Pass (8.4 x 10 ⁹ ohms) Pass (1.5 x 10 ¹² ohms)
Electrochemical Migration	3.9.2	< 1 decade drop, no dendritic growth	Pass

Additional Tests / Results

TEST	REQUIREMENT	RESULT
CTI (Comparative Tracking Index)	ASTM-D-3638-07	600 Volts
Halogen Content	Halogen-Free if < 900 ppm	Pass-400 ppm
Dielectric Constant	Internal Test at:	
	1 MHz	3.6
	10 MHz	3.4
	100 MHz	3.3
	1 GHz	3.5
Dissipation Factor	Internal Test at:	
	1 GHz	0.019
Electroless Nickel / Immersion Gold Resistance	Tape Test Adhesion	Pass

Taiyo America, Inc. (TAIYO) warrants its products to be free from defects in materials and workmanship for the specified warranty period (**PSR-4000 HFX Series Blue / CA-40 HF Warranty period is 9 Months)** provided the customer has, at all times, stored the ink at a temperature of 68°F or less. TAIYO accepts no responsibility or liability for damages, whether direct, indirect, or consequential, resulting from failure in the performance of its products. If a TAIYO product is found to be defective in material or workmanship, its liability is limited to the purchase price of the product found to be defective. TAIYO MAKES NO OTHER WARRANTY, EXPRESS OR IMPLIED, AND MAKES NO WARRANTY OF MERCHANTABILITY OR OF FITNESS FOR ANY PARTICULAR PURPOSE. TAIYO'S obligation under this warranty shall not include any transportation charges or costs of installation or any liability for direct, indirect, or consequential damages or delay. If requested by TAIYO, products for which a warranty claim is made are to be returned transportation prepaid to TAIYO'S factory. Any improper use or any alteration of TAIYO'S product by the customer, as in TAIYO'S judgment affects the product materially and adversely, shall void this limited warranty.

6 | Page

Revised May 23, 2016

2675 Antler Drive • Carson City, NV 89701 • Phone [775] 885-9959 • Fax [775] 885-9972 • www.taiyo-america.com